DATA SHEET

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Package Code No.	FLGA324-C1515

SEMICONDUCTOR COMPANY MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD.

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MN103S5405YD

Chip-set for Digital Still Camera

Overview

Key devices required for a digital still camera are integrated into this chip set.

We can accommodate marketing needs by providing a total solution, which includes M-pixels CCD image sensor, high picture quality and high efficiency single processing LSI, power supply, audio playback, and LCD.

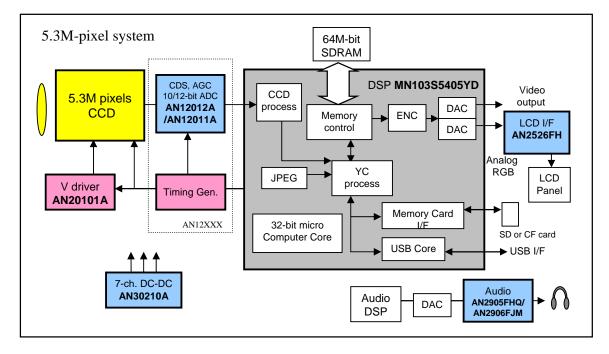
Features

- High picture quality CCD provides high sensitivity and broad dynamic range by a new structure.
- 8-ch. Vertical Driver IC: Suitable for high pixel size frame readout CCD
- Front End IC includes 10/12-bit AD converter, Liner Gain Control Amp
- High-performance Image Processing DSP, with moving/still
- 7-ch. DC-DC control IC
- LCD I/F for adjustment with Bus Control
- Low voltage operation audio processing IC

Applications

• Digital Still Cameras, OA, FA Cameras

System Block Diagram



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